

**Fwd: You have a job offer for Systems Engineer role at Infosys**

2 messages

**Varsha Pattanashetti** <pattanashettivarsha@gmail.com>  
To: placement@hsit.ac.in

Wed, Jun 22, 2022 at 9:03 PM

----- Forwarded message -----

From: **Varsha Pattanashetti** <pattanashettivarsha@gmail.com>  
Date: Fri, 22 Apr 2022, 11:56 am  
Subject: Fwd: You have a job offer for Systems Engineer role at Infosys  
To: <shrediwan@gmail.com>

----- Forwarded message -----

From: **Infosys Freshers Recruitment** <Talent.Acquisition@infosys.com>  
Date: Fri, 22 Apr 2022, 11:27 am  
Subject: You have a job offer for Systems Engineer role at Infosys  
To: Infosys Freshers Recruitment <Talent.Acquisition@infosys.com>

Dear Student,

Thank you for participating in the Infosys recruitment process. Congratulations! You have cleared the interview round of the process.

**We are delighted to offer you the position of Systems Engineer at Infosys.**

The compensation for this role is INR 3.6 lakhs per annum with one year of probation period from the date of allocation to the business unit. Additional benefits include health insurance of INR 4 lakhs per annum and a life cover of INR 30 lakhs.

You will soon hear from us about the next steps of the process.

Please note, this is a conditional job offer subject to your background verification. If falsification of data is detected during the background verification process, Infosys will revoke the job offer made to you.

In case of any queries, please contact your placement office or write to us at [Talent.Acquisition@infosys.com](mailto:Talent.Acquisition@infosys.com).

We look forward to welcoming you into the Infosys family.

Best regards,

Talent Acquisition  
Infosys

2 attachments



image001.jpg

60K

Akshata M P <akshatamp2704@gmail.com>  
To: "placement@hsit.ac.in" <placement@hsit.ac.in>

Thu, Jun 23, 2022 at 8:03 PM

[Quoted text hidden]

2 attachments



image001.jpg

60K

9-04-2022

To

varsha pattanashetti  
pattanashettivarsha@gmail.com  
9740494865  
Dept of CSE  
Hirasugar institute of technology Nidasoshi

**Sub: Letter of Intent: Technology Training and Placement under CSR**

Dear varsha pattanashetti

We are pleased to inform you that you have been selected for **CSR-Incubation batch of Technology Training and Placement** which is of free of cost for merit students.

By PalleTechnologies, Bangalore.

**The program will begin on 12<sup>TH</sup> APRIL 2022 Tuesday (COURSE DURATION: 3.5 MONTHS)**

**The Mode of Training will be Online – Using Zoom App.**

**The Training will be conducted every day between 6:30 PM to 8 PM.**

During this Program you will be having Technology Training

1. Monday to Friday – Training, and Saturday Evaluation & interview preparation.

Program features:

1. Aptitude & reasoning training
2. Technology training on Java, OOPs, sql, Web Technologies, & Python
3. Assignments – coding & aptitude
4. System tests on regular basis
5. Coding interview preparation
6. Mock technical interviews
7. Mock HR interviews
8. We will schedule unlimited number of interviews with our esteemed clients with packages starting from 2.4 LPA to 6 LPA until student gets placed
9. Course Completion Certificate will be provided after the successful completion of the Technology training
10. If student misses any one class during training period, then student will be dropped from the program and will not be eligible for free training and placements.

- 
11. If student has not attended any interview scheduled by Palle Technologies, then student will be disqualified from the program and will not be eligible for free training and placements.

Mandatory Requirements while joining:

- (1) Student has to send a photo copy of his or her X, XII mark sheets
- (2) Student has to send a photo copy of Engineering all semester mark sheets up to 6<sup>th</sup> semester
- (3) Student has to send photo copy of Adhar card
- (4) Student has to send photo copy of college ID proof
- (5) Student has to send his or her pass port size photo

**We look forward to welcome you on board.**

**Sincerely,  
HR Team  
Palle Technologies**